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PATENT

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U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter "ASSIGNOR") by

| (Insert | Semiconductor Technology Academic Research Center | | | | | | | | | |
|--|---|--------------------------------------|---|----------------|--|--|--|--|--|--|
| ASSIGNEE's Name(s) | 17-2, Shin Yokohama 3-chome, Kouhoku-ku, Yokohama-shi, | | | | | | | | | |
| Address(es)) | Kanagawa 222-003 | 3 Japan | | | | | | | | |
| (Title of Invention) | (hereinafter "ASSIGNEE"), the receipt transfers to ASSIGNEE the entire and DATA PROCESSOR | • | | s, assigns and | | | | | | |
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| | IN WITNESS WHEREOF, th | ne undersigned inventor(s) has (have | e) affixed his/her/their signature(s). | | | | | | | |
| (Signatures) | 1) VI reale Wishipawa (SIGNATURE) | Hiroaki Nishikawa | September 17, 2004 | | | | | | | |
| | 2 Hiroshi Jonyasu (SIGNATURE) | Hiroshi Tomiyasu | September 17, 2004 | | | | | | | |
| | 3) Ryosuke Kurebayashi (SIGNATURE) | Ryosuke Kurebayashi | September 17, 2004 | | | | | | | |
| | 4) Stryp Deles (SIGNATURE) | Shinya Ito | September 17, 2004 | | | | | | | |
| | 51 Shouhei Nome to (SIGNATURE) | Shouhei Namoto | September 17, 2004 | | | | | | | |
| | 6) | | | | | | | | | |
| | (SIGNATURE) | (TYPE NAME) | (DATE) | | | | | | | |

RECORDED: 09/30/2004

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